

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
INCT CO., LTD.	06/27/2017
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Property Type	Number
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DATE SIGNED:	07/03/2017
Total Attachments: 1	
source=Executed Assignment from INCT Co., Ltd. to changgunenc (as filed) 7-3-17#page1.tif	

ASSIGNMENT

WHEREAS, INCT CO., LTD. (hereinafter "Assignor"), a Korean company organized and existing under the laws of the Republic of Korea, located and doing business at 5F, Shinsung Bldg. 321-1, Yangjae-dong, Seocho-gu, Seoul, REPUBLIC OF KOREA 137-848, is the sole and exclusive owner of all rights, including all intellectual property rights, in U.S. Patent Application Serial No. 13/877,146, titled FLOOR SLAB STRUCTURE FOR BRIDGE, which was filed on March 29, 2013, and

WHEREAS, changgunenc (hereinafter "Assignee"), a Korean company organized and existing under the laws of the Republic of Korea, with a mailing address of 946, Jingwang-ro, Naechon-ri, Iwol-myeon, Jincheon-gun, Chungcheongbuk-do 27815 Republic of Korea, desires to acquire all rights in U.S. Patent Application Serial No. 13/877,146;

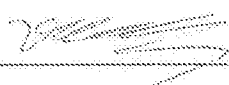
NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the parties hereby agree as follows.

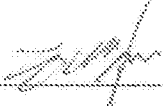
Patent Assignment - Assignor does hereby assign unto Assignee all right, title, and interest in and to U.S. Patent Application Serial No. 13/877,146, including any and all Letters Patent based thereon now or in the future granted in the United States and its territorial possessions and in any and all foreign jurisdictions, and in and to any and all divisions, continuations, reissues, reexaminations, and extensions thereof, and all claims for infringement thereof both arising prior to and on or after the effective date of this Assignment, which is the date of last signature below.

Agreed:

INCT CO., LTD.

changgunenc

Signature: 

Signature: 

Printed Name: Yoo, Hyosik

Printed Name: HAN, Youngkyun

Title: CEO

Title: CEO

Date: June 27, 2017

Date: June 27, 2017